电子工程 是 Times China 专辑

2024 Editorial Calendar

Issue	Cover Story	Trend & Analysis				Design & Technology			
		Industry Trends	Opinions	Interview	Innovations	Design Corner	Test & Measurement	New Products	Hardware Innovation
January Ad Booking Deadline: 23-Nov-2023 Ad Materials Deadline: 28-Nov-2023	New year outlook					- PCB Design - High Frequency Design - Embedded Design	Power Integrity Measurement		
February Ad Booking Deadline: 22-Dec-2023 Ad Materials Deadline: 28-Dec-2023	The road to commercialization of MicroLED	•	•	•	•	- Mixed Signal Circuit Design - Data Security and Encryption - MCU	Microwave RF Test	•	
March Ad Booking Deadline: 19-Jan-2024 Ad Materials Deadline: 22-Jan-2024	EDA technology and industry trends	•	•	•	•	- Smart Grid - Wireless Communication - Analog Circuit Design	Oscilloscope	•	•
April Ad Booking Deadline: 23-Feb-2024 Ad Materials Deadline: 28-Feb-2024	GPU/image processor	•	•	•	•	- LED Lighting - Photoelectric and Display - MEMS Sensor	EMI Test	•	
May Ad Booking Deadline: 22-Mar-2024 Ad Materials Deadline: 28-Mar-2024	Motor drive and control	•	•	•	•	- Motor Control - RF/Microwave - Servo Control	Network Analyzer	•	•
June Ad Booking Deadline: 23-Apr-2024 Ad Materials Deadline: 29-Apr-2024	LLM and semiconductor industry	•	•	•	•	Wearable Gadget DesignEnergy AcquisitionDigital Signal Processing	Test Software /IP	•	
July Ad Booking Deadline: 23-May-2024 Ad Materials Deadline: 28-May-2024	Automobile intelligence and connectivity	•	•	•	•	- Medical Electronics- ADC/DAC- Edge Computing	Signal Integrity Measurement	•	•
August Ad Booking Deadline: 21-Jun-2024 Ad Materials Deadline: 28-Jun-2024	3D-IC/3D NAND	•	•	•	•	- Audio Design - FPGA/DSP - Wafer Foundry	Impedance Measurement	•	
September Ad Booking Deadline: 23-Jul-2024 Ad Materials Deadline: 26-Jul-2024	Foundry/ANG process	•	•	•	•	- EMI/EMC - Circuit Protection - Radar Technology	Embedded System Test	•	•
October Ad Booking Deadline: 23-Aug-2024 Ad Materials Deadline: 28-Aug-2024	RISC-V architecture ecology	•	•	•	•	- Human-Machine Interaction- Touch Technology- Speech Recognition / Processing	Mixed Signal Measurement	•	•
November Ad Booking Deadline: 22-Sep-2024 Ad Materials Deadline: 27-Sep-2024	Advanced packaging technology	•	•	•	•	- Power Device- Low Power Design- Digital Power	Vector Signal Analysis	•	•
December Ad Booking Deadline: 23-Oct-2024 Ad Materials Deadline: 28-Oct-2024	Silicon carbide/wide bandgap semiconductor	•	•	•	•	- 5G Communication- Wireless Connection- Video Surveillance	Spectrum Analyzer	•	

^{*} Simplified Chinese only

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Editorial inquiries